

Industrial 3D NAND M.2 2242 SSD

MDA350 SERIES

SATA III

6.0 Gbit/s

SLC Cache

3D NAND



PRODUCT FEATURES

- High-Quality 3D NAND Flash Technology
- Global Wear Leveling and Early weak block retirement
- TRIM, NCQ, DEVSLP, ATA Security Feature Set supported
- Lifetime Enhancements

Direct-to-TLC and SLC Cache enhancement to ensure the optimized WAF

Block/Page RAID function to ensure data recovery

StaticDataRefresh to keep data integrity

- Reliable Industrial grade integrated Active PMU and complete protection design with OVP, OCP, surge rejection and Short protection
- External DRAM to achieve the optimal sustained read/write performance
- Power shielding firmware architecture to ensure power failure resilience
- AES256 Encryption and TCG Opal 2.0 compliant (by request)
- SP SMART Toolbox
- SP SMART Embedded and SMART IoT service (by request)

PRODUCT SUMMARY

- Capacities : 64GB, 128GB, 256GB, 512GB
- Form Factor : M.2 2242 SATA Solid State Drive (42 mm x 22 mm x 3.5 mm)
- Compliance : SATA Revision 3.1 - 6 Gbit/s (3 Gbit/s and 1.5 Gbit/s backward compatible)
- Command Sets : Supports ATA/ATAPI-8 and ACS-2
- Performance :

	64GB	128GB	256GB	512GB
Sequential Read (MB/s Max.)	360	520	520	520
Sequential Write (MB/s Max.)	190	360	400	465
Random 4K Read (IOPS Max.)	25000	26000	29000	84000
Random 4K Write (IOPS Max.)	18000	31000	26000	84000

** Actual performance may vary based on the specific model and capacity*

- Operating Temperature Range :
Normal : 0°C to 70°C
Extended : -15°C to 85°C (by request)
Wide : -40°C to 85°C (by request)
- Storage Temperature Range : -55°C to 95°C
- Operating Voltage : 3.3V ± 10%
- Power Consumption :

(Unit: mA)	64GB	128GB	256GB	512GB
Read (Max.)	370	415	415	450
Write (Max.)	430	510	520	550
Stand-by (Avg.)	160	160	160	160

** Actual value may vary based on the specific model and capacity*

- Data Retention @40 °C : 10 Years @ Life Begin; 1 Year @ Life End
- Endurance in Tera Bytes Written (TBW) : (Unit: TB)

Workload	64GB	128GB	256GB	512GB
Sequential	187	375	750	1500
Enterprise	29	59	118	236

TBW is estimated by formula **TBW = (Capacity x PE Cycles) x (1+OP) x (WLE) / (WAF)**

OP (Over Provision) = (Physical Capacity / Logical Capacity)-1

WAF = Write Amplification Factor

WLE = Wear Leveling Efficiency could be different depended on the workload or usage containing data size and access rate.

Sequential workload: Sequential write workload which is generated by VDBENCH script and tested by VDBENCH

Enterprise workload: Follow JESD219A enterprise workload which is generated by VDBENCH script and tested by VDBENCH.

- Mechanical (IEC-60068) :
Vibration : 15G, 10 ~ 2001Hz
Drop : 76cm
Shock : 1,500G@0.6ms
- LDPC ECC engine and Block/Page RAID to ensure reliable 3K PE cycles
- Mean Time Between Failure : > 2,000,000 hours
- Data Reliability: Non-recover Read (UBER) ≤10⁻¹⁶
- Serious quality control and assurance
100% NAND Flash screening
High endurance product design with 3D NAND and pSLC product offerings
Implement high/low temperature dynamic burn-in in each lot production to monitor production quality to meet design specification
Reliability criteria compliant with international standards IEC-60068/61000